

# EA1012DA10-38.400M TR [Click part number to visit Part Number Details page](#)

## REGULATORY COMPLIANCE (Data Sheet downloaded on Jun 21, 2020)



◀ Click badges to download compliance docs

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## ITEM DESCRIPTION

Quartz Crystal Resonator 1.0mm x 1.2mm x 0.33mm 4 Pad Ceramic Surface Mount (SMD) 38.400MHz  $\pm 15$ ppm at 25°C,  $\pm 30$ ppm over -10°C to +60°C 10pF Parallel Resonant

## ELECTRICAL SPECIFICATIONS

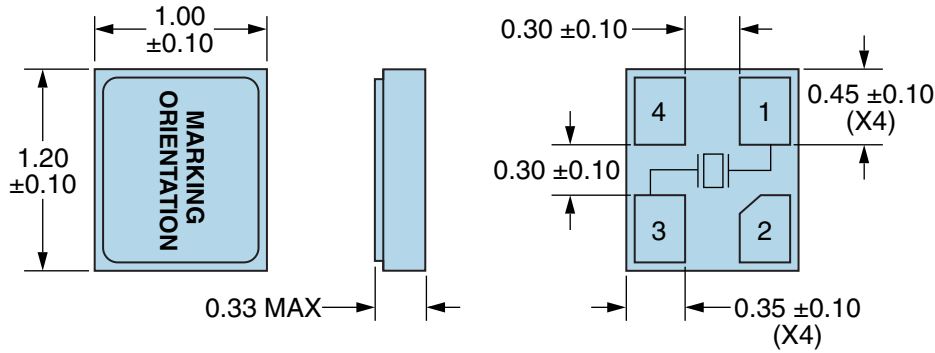
|                               |  |
|-------------------------------|--|
| Nominal Frequency             | 38.400MHz  |
| Frequency Tolerance/Stability | $\pm 15$ ppm at 25°C, $\pm 30$ ppm over -10°C to +60°C |
| Aging at 25°C                 | $\pm 3$ ppm/year Maximum                               |
| Load Capacitance              | 10pF Parallel Resonant                                 |
| Shunt Capacitance             | 5pF Maximum  |
| Equivalent Series Resistance  | 60 Ohms Maximum  |
| Mode of Operation             | AT-Cut Fundamental                                     |
| Drive Level                   | 100 $\mu$ Watts Maximum                                |
| Spurious Response             | -3dB Minimum (Measured from Fo to Fo +5000ppm)         |
| Storage Temperature Range     | -40°C to +85°C   |
| Insulation Resistance         | 500 Megaohms Minimum (Measured at 100Vdc)              |

## ENVIRONMENTAL & MECHANICAL SPECIFICATIONS

|                              |   |
|------------------------------|---|
| ESD Susceptibility           | MIL-STD-883, Method 3015, Class 1, HBM: 1500V |
| Fine Leak Test               | MIL-STD-883, Method 1014, Condition A         |
| Flammability                 | UL94-V0                                       |
| Gross Leak Test              | MIL-STD-883, Method 1014, Condition C         |
| Mechanical Shock             | MIL-STD-883, Method 2002, Condition B         |
| Moisture Resistance          | MIL-STD-883, Method 1004                      |
| Moisture Sensitivity         | J-STD-020, MSL 1                              |
| Resistance to Soldering Heat | MIL-STD-202, Method 210, Condition K          |
| Resistance to Solvents       | MIL-STD-202, Method 215                       |
| Solderability                | MIL-STD-883, Method 2003                      |
| Temperature Cycling          | MIL-STD-883, Method 1010, Condition B         |
| Vibration                    | MIL-STD-883, Method 2007, Condition A         |

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### MECHANICAL DIMENSIONS (all dimensions in millimeters)



| PIN | CONNECTION   |
|-----|--------------|
| 1   | Crystal      |
| 2   | Cover/Ground |
| 3   | Crystal      |
| 4   | No Connect   |

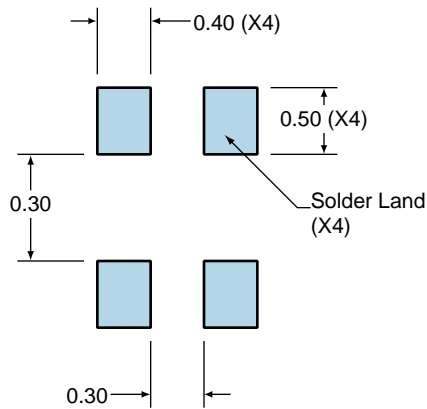
| LINE | MARKING  |
|------|--|
| 1    | <b>XXXX</b><br>XXXX=Ecliptek<br>Manufacturing Identifier |

### Electron-Beam Sealed

**Terminal Plating Thickness:** Gold (0.3 to 1.0µm) over Nickel (1.27 to 8.89µm).

### Suggested Solder Pad Layout

All Dimensions in Millimeters



All Tolerances are ±0.1

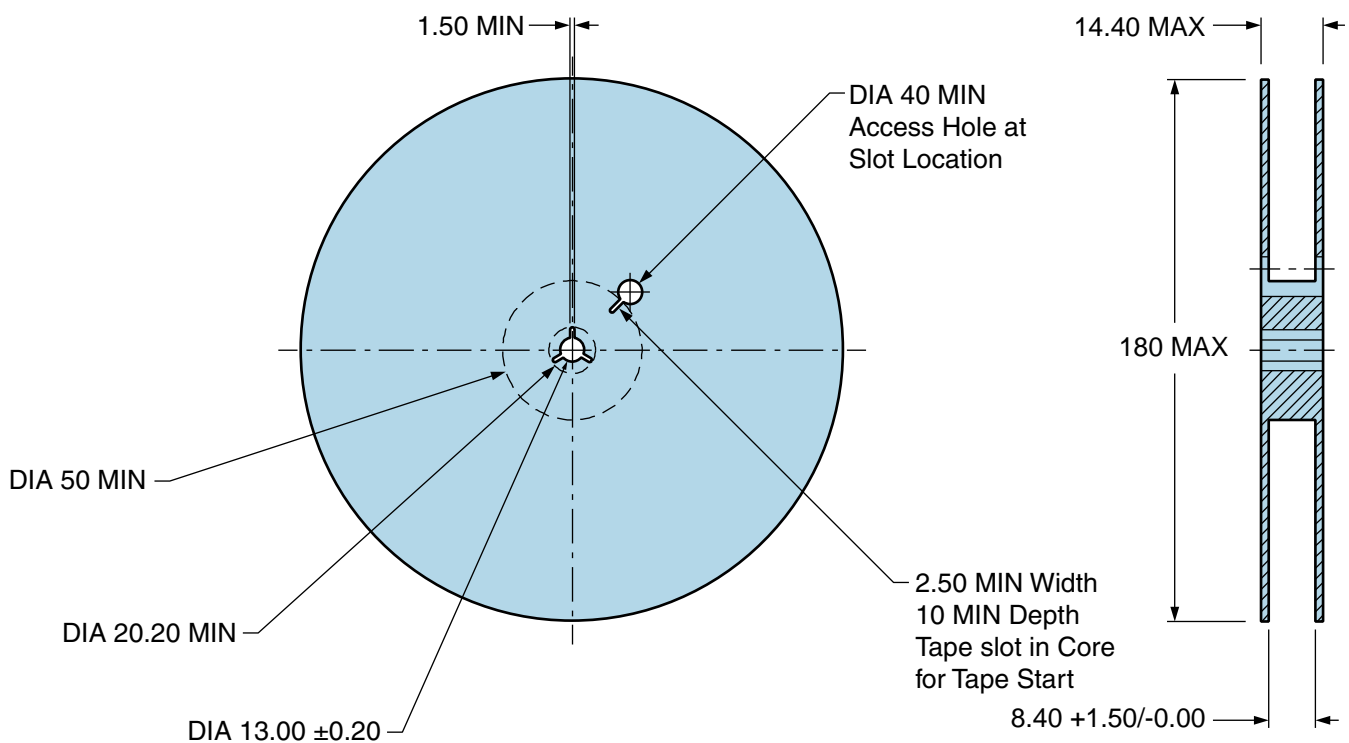
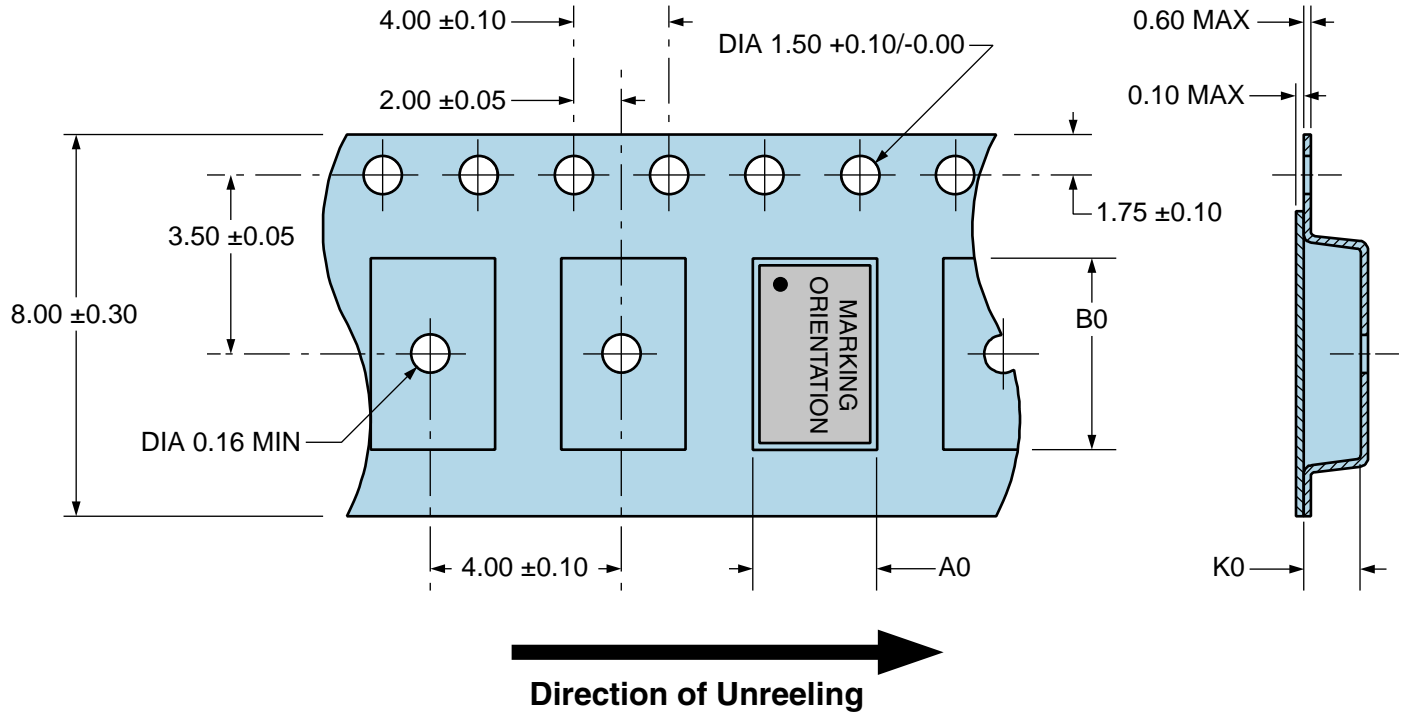
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## Tape & Reel Dimensions

Quantity Maximum Per Reel: 5,000 units

All Dimensions in Millimeters

Compliant to EIA-481



**EA1012DA10-38.400M TR** [Click part number to visit Part Number Details page](#)
**Recommended Solder Reflow Methods**

**High Temperature Infrared/Convection**

|  |   |
|--|---|
| <b>Ts MAX to Tl (Ramp-up Rate)</b>         | 3°C/Second Maximum                                |
| <b>Preheat</b>                             |   |
| - Temperature Minimum (Ts MIN)             | 150°C   |
| - Temperature Typical (Ts TYP)             | 175°C   |
| - Temperature Maximum (Ts MAX)             | 200°C   |
| - Time (ts MIN)                            | 60 - 180 Seconds                                  |
| <b>Ramp-up Rate (Tl to Tp)</b>             | 3°C/Second Maximum                                |
| <b>Time Maintained Above:</b>              |   |
| - Temperature (Tl)                         | 217°C   |
| - Time (tL)                                | 60 - 150 Seconds                                  |
| <b>Peak Temperature (Tp)</b>               | 260°C Maximum for 10 Seconds Maximum              |
| <b>Target Peak Temperature (Tp Target)</b> | 250°C +0/-5°C                                     |
| <b>Time within 5°C of actual peak (tp)</b> | 20 - 40 Seconds                                   |
| <b>Ramp-down Rate</b>                      | 6°C/Second Maximum                                |
| <b>Time 25°C to Peak Temperature (t)</b>   | 8 Minutes Maximum                                 |
| <b>Moisture Sensitivity Level</b>          | Level 1   |
| <b>Additional Notes</b>                    | Temperatures shown are applied to body of device. |

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## Recommended Solder Reflow Methods



### Low Temperature Infrared/Convection 245°C

|  |  |
|--|--|
| Ts MAX to TL (Ramp-up Rate)                | 5°C/Second Maximum                                     |
| <b>Preheat</b>                             |  |
| - Temperature Minimum (Ts MIN)             | N/A  |
| - Temperature Typical (Ts TYP)             | 150°C  |
| - Temperature Maximum (Ts MAX)             | N/A  |
| - Time (ts MIN)                            | 30 - 60 Seconds  |
| <b>Ramp-up Rate (TL to TP)</b>             | 5°C/Second Maximum                                     |
| <b>Time Maintained Above:</b>              |  |
| - Temperature (TL)                         | 150°C  |
| - Time (tL)                                | 200 Seconds Maximum                                    |
| <b>Peak Temperature (TP)</b>               | 245°C Maximum  |
| <b>Target Peak Temperature (TP Target)</b> | 245°C Maximum 2 Times / 230°C Maximum 1 Time           |
| <b>Time within 5°C of actual peak (tp)</b> | 10 Seconds Maximum 2 Times / 80 Seconds Maximum 1 Time |
| <b>Ramp-down Rate</b>                      | 5°C/Second Maximum                                     |
| <b>Time 25°C to Peak Temperature (t)</b>   | N/A  |
| <b>Moisture Sensitivity Level</b>          | Level 1  |
| <b>Additional Notes</b>                    | Temperatures shown are applied to body of device.      |

### Low Temperature Manual Soldering

185°C Maximum for 10 Seconds Maximum, 2 times Maximum. (Temperatures shown are applied to body of device.)

### High Temperature Manual Soldering

260°C Maximum for 5 Seconds Maximum, 2 times Maximum. (Temperatures shown are applied to body of device.)

# Mouser Electronics

Authorized Distributor

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[EA1012DA10-38.400M TR](#)



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- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



#### Как с нами связаться

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